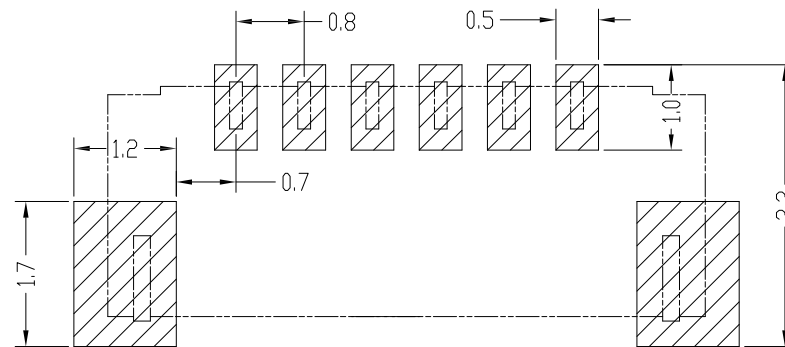
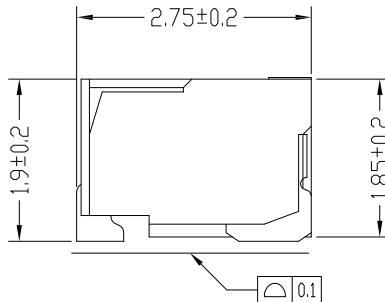
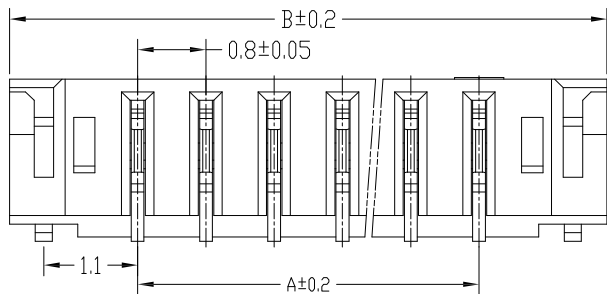
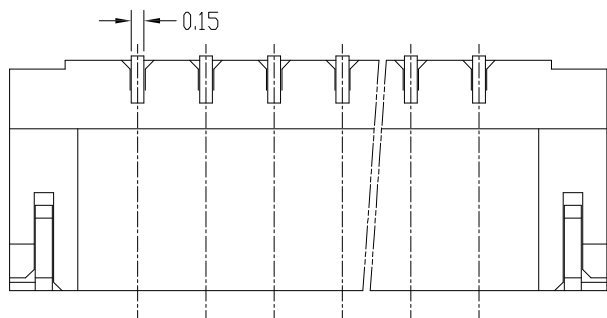




PCB LAYOUT



15	11.2	14.2			
14	10.4	13.4			
13	9.6	12.6			
12	8.8	11.8			
11	8.0	11.0	25	19.0	22.0
10	7.2	10.2	24	18.2	21.2
9	6.4	9.4	23	17.4	20.4
8	5.6	8.6	22	16.6	19.6
7	4.8	7.8	21	15.8	18.8
6	4.0	7.0	20	15.0	18.0
5	3.2	6.2	19	14.2	17.2
4	2.4	5.4	18	13.4	16.4
3	1.6	4.6	17	12.8	15.8
2	0.8	3.8	16	12.0	15.0
孔位	DIM A	DIM B	孔位	DIM A	DIM B

主要技术参数 Main Specifications

线 数 (Poles): 02 to 25

接触电阻 (Contact resistance): $\leq 20m\Omega$

绝缘电阻 (Insulation resistance): $\geq 100M\Omega$

额定电压 (Rated voltage): 30V AC DC

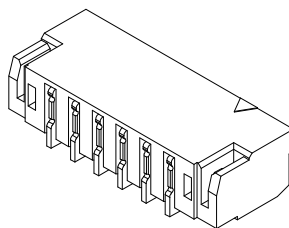
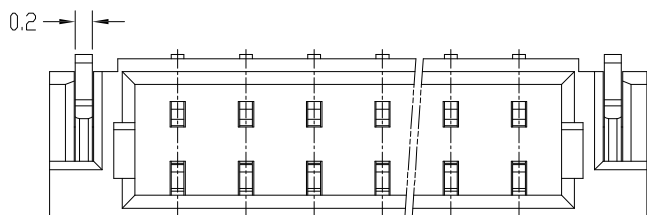
额定电流 (Rated current): 0.5A AC DC

耐 电 压 (Withstand Voltage): 200V AC/minute

温度范围 (Temperature Range): $-25^{\circ}C \sim +85^{\circ}C$

ORDER INFORMATION:

PART No. _____		A0801AWR-**-F4M*1-*		PACKAGING: R=REEL P=PE	
No.OF CIRCUITS: 02~25				Metal code: 1=PhosphorBronze	
PLASTIC MATERIAL: F4M=LCP(BEIGE)				PLATING: B=MATTE Sn C=GOLD	



C	Soldet TAB		2 PCS	PhosphorBronze	Matte Sn-plated
B	CONTACT		n PCS	PhosphorBronze	Matte Sn-plated/GOLD
A	HOUSING		1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH

X.± 0.3	X°.± 5°
.X± 0.25	.X°.± 2°
.XX± 0.20	.XX°.± 1°
.XXX± 0.10	.XXX°.± 0.5°

UNITS mm	QWYCONN® 深圳市启崴源电子有限公司 SHENZHEN QIWEIYUAN ELECTRONIC CO., LTD.				
MAT'L	PART NO.(INTENDED USE) A0801AWR-**-F4M*1-*		TITLE: 0.8mmPITCH 90°WAFER SMT TYPE		
FINISH	APPD:		DWG NO.: QWY-GCCP-0705		
Q'TY PCS	CHKD:				
	DR: HU 2016.09.28				
			SCALE 1/1	SHEET 1/1	REV. A